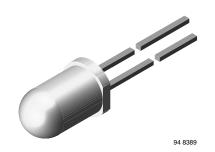
TSFF6210



Vishay Semiconductors

High Speed Infrared Emitting Diode, 870 nm, **GaAlAs Double Hetero**



TSFF6210 is an infrared, 870 nm emitting diode in GaAlAs double hetero (DH) technology with high radiant power and

high speed, molded in a clear, untinted plastic package.

FEATURES

- Package type: leaded
- Package form: T-1¾
- Dimensions (in mm) = Ø 5
- Peak wavelength: $\lambda_p = 870 \text{ nm}$
- High reliability
- High radiant power
- · High radiant intensity
- Angle of half intensity: $\varphi = \pm 10^{\circ}$
- · Low forward voltage
- Suitable for high pulse current operation
- High modulation bandwidth: f_c = 24 MHz
- · Good spectral matching with Si photodetectors
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Note

Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

APPLICATIONS

- Infrared video data transmission between Camcorder and TV set
- · Free air data transmission systems with high modulation frequencies or high data transmission rate requirements
- · Smoke-automatic fire detectors

PRODUCT SUMMARY COMPONENT Ie (mW/sr) φ (deg) λ_p (nm) t_r (ns) **TSFF6210** 180 ± 10 870 15

Note

DESCRIPTION

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION							
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM				
TSFF6210	Bulk	MOQ: 4000 pcs, 4000 pcs/bulk	T-1¾				

Note

MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Reverse voltage		V _R	5	V			
Forward current		I _F	100	mA			
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	200	mA			
Surge forward current	t _p = 100 μs	I _{FSM}	1	A			
Power dissipation		Pv	180	mW			
Junction temperature		Тj	100	°C			
Operating temperature range		T _{amb}	- 40 to + 85	°C			
Storage temperature range		T _{stg}	- 40 to + 100	°C			
Soldering temperature	$t \le 5$ s, 2 mm from case	T _{sd}	260	°C			
Thermal resistance junction/ambient	J-STD-051, leads 7 mm, soldered on PCB	R _{thJA}	230	K/W			



COMPLIANT

GREEN (5-2008)**





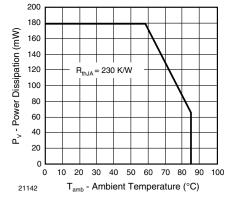


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

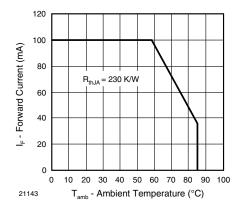


Fig. 1 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Forward voltage	I _F = 100 mA, t _p = 20 ms	V _F		1.5	1.8	V	
	I _F = 1 A, t _p = 100 μs	V _F		2.3	3.0	V	
Temperature coefficient of V_F	I _F = 1 mA	TK _{VF}		- 1.8		mV/K	
Reverse current	V _R = 5 V	I _R			10	μA	
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0$	Cj		125		pF	
De die at interación	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l _e	90	180	450	mW/sr	
Radiant intensity	I _F = 1 A, t _p = 100 μs	l _e		1800		mW/sr	
Radiant power	I _F = 100 mA, t _p = 20 ms	фе		50		mW	
Temperature coefficient of ϕ_{e}	l _F = 100 mA	TKφ _e		- 0.35		%/K	
Angle of half intensity		φ		± 10		deg	
Peak wavelength	I _F = 100 mA	λ _p		870		nm	
Spectral bandwidth	l _F = 100 mA	Δλ		40		nm	
Temperature coefficient of λ_p	l _F = 100 mA	ΤΚλρ		0.25		nm/K	
Rise time	l _F = 100 mA	t _r		15		ns	
Fall time	l _F = 100 mA	t _f		15		ns	
Cut-off frequency	$I_{DC} = 70$ mA, $I_{AC} = 30$ mA pp	f _c		24		MHz	
Virtual source diameter		d		3.7		mm	



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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

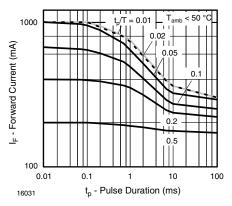


Fig. 2 - Pulse Forward Current vs. Pulse Duration

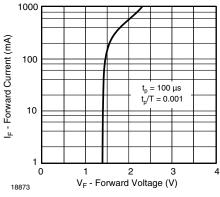


Fig. 3 - Forward Current vs. Forward Voltage

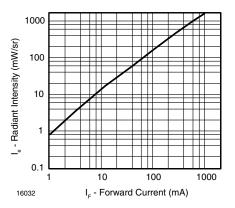


Fig. 4 - Radiant Intensity vs. Forward Current

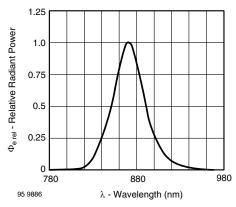


Fig. 5 - Relative Radiant Power vs. Wavelength

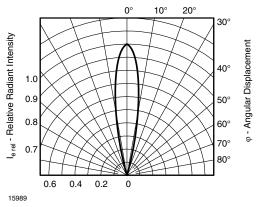


Fig. 6 - Relative Radiant Intensity vs. Angular Displacement

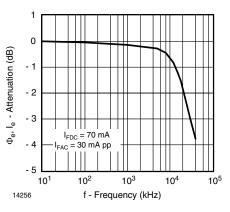


Fig. 7 - Attenuation vs. Frequency

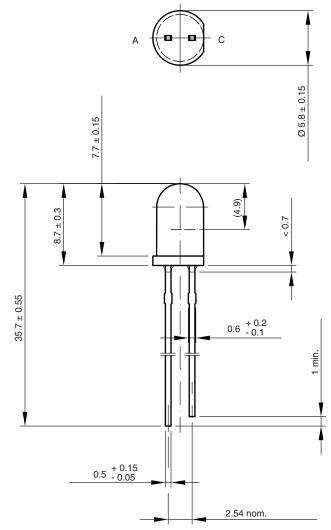
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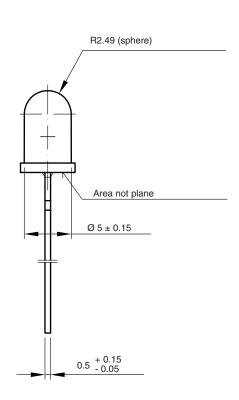
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PACKAGE DIMENSIONS in millimeters



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technical drawings according to DIN specifications

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